AMENDMENT TO THE CLAIMS

Please AMEND claim 2 as follows.

A copy of all pending claims (including status identifiers) is provided below.

- 1. (previously presented) Process for finishing a wood or wooden board, in particular an MDF or HDF board with an upper side and an underside, comprising the following steps:
 - a) applying a sealing layer of melamine resin to the upper side of the board,
 - b) printing a decoration onto the sealing layer,
 - c) applying a protective layer of melamine resin to the decoration, and
- d) pressing the board under the action of temperature until the protective layer and the sealing layer melt and bond to each other with the inclusion of the decoration printed thereon.
- 2. (currently amended) The process as claimed in claim 1, further comprising the following steps:

applying a sealing layer of melamine resin to the underside of the board, applying a colored layer to the sealing layer on the upper sideunderside of the board, applying the a protective layer of melamine resin to the decoration colored layer, and pressing the board under the action of temperature until the protective layer and the sealing layer melt and bond to each other with the inclusion of the colored layer.

3. (original) The process according to claim 1, wherein the upper side and the underside are finished at the same time.

- 4. (original) The process according to claim 1, wherein a plurality of individual layers are applied for at least one of the sealing layer and the protective layer and each individual layer dries out before the application of the next.
- 5. (original) The process according to claim 2, wherein the board is ground before the sealing layer is applied.
- 6. (original) The process according to claim 4, further comprising providing corundum into at least one individual layer of the protective layer.
- 7. (original) The process according to claim 4, further comprising scattering corundum onto at least one individual layer of the protective layer.
- 8. (original) The process according to claim 4, further comprising mixing at least one of antibacterial and antistatic additives into at least one individual layer of the protective layer.
- 9. (original) The process according to claim 4, further comprising scattering at least one of antibacterial and antistatic additives onto at least one individual layer of the protective layer.
- 10. (original) The process according to claim 1, further comprising providing at least one filler into at least one of a sealing layer and the protective layer.

- 11. (original) The process according to claim 10, wherein the filler is wood fibers, wood dust, metals, mineral substances, plastics or ash.
- 12. (original) The process according to claim 1, wherein finishing of the upper side of the board is carried out only in some regions.
- 13. (original) The process according to claim 10, wherein finishing is carried out on an area running obliquely with respect to the upper side.
- 14. (original) The process according to claim 1, wherein a structure or at least one V joint is impressed into the protective layer.
- 15. 25. (canceled)
- 26. (previously presented) The process according to claim 14, further comprising sawing the board centrally along the at least one V joint to create panels each having a chamfered edge.
- 27. (previously presented) The process of claim 1, wherein the applying the sealing layer and the printing are devoid of paper layers.
- 28. (previously presented) The process of claim 1, wherein the printing a decoration onto the sealing layer prevents impregnation of the printing onto the board.

29. (previously presented) The process of claim 1, further comprising:

grinding the board before the applying the sealing layer,

impressing a V-joint into the protective layer; and

sawing the board centrally along the at least one V joint to create panels each having a chamfered edge.

30. (previously presented) The process of claim 1, wherein:

the board is ground before the sealing layer is applied,

the sealing layer prevents printing ink from being absorbed by the board,

the applying the sealing layer includes applying a first plurality of layers, each individual layer of the first plurality of layers drying out before application of a next layer, and

the applying the protective layer includes applying a second plurality of layers, each individual layer of the second plurality of layers drying out before application of a next layer.